

SID

Factory: Rot am See

Article:

ML6

Provided:

Customer:

Date:

03.04.2026

WÜRTH
ELEKTRONIK
MORE THAN
YOU EXPECT

Processtechnology: B: undefined

Material Text	Mat. Nr.	µm	Stackup	Process overview
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A-RS Kupferfolie-035my 330x490mm	50200242	35	VS	1	
C-RAS-FR4-PP-2116-H53-TG150-HF-EM-37B...	50203001	215		2	
C-RAS-FR4-PP-2116-H53-TG150-HF-EM-37B...	50203001	0		3	
C-RAS-FR4-PP-1080-H63-TG150-HF-EM-37B...	50203000	60		4	
C-RaS-FR4-ML-0.508mm-105+105-TG150-HF...	50203129	105	L2		
		510		5	A01
		105	L3		
C-RAS-FR4-PP-1080-H63-TG150-HF-EM-37B...	50203000	50		6	
C-RAS-FR4-PP-2116-H53-TG150-HF-EM-37B...	50203001	205		7	
C-RAS-FR4-PP-2116-H53-TG150-HF-EM-37B...	50203001	0		8	B00
C-RAS-FR4-PP-1080-H63-TG150-HF-EM-37B...	50203000	50		9	
C-RAS-ML-0.51-0105+0105-460x305-TG150H...	50202749	105	L4		
		510		10	A02
		105	L5		
C-RAS-FR4-PP-1080-H63-TG150-HF-EM-37B...	50203000	60		11	
C-RAS-FR4-PP-2116-H53-TG150-HF-EM-37B...	50203001	215		12	
C-RAS-FR4-PP-2116-H53-TG150-HF-EM-37B...	50203001	0		13	
A-RS Kupferfolie-035my 330x490mm	50200242	35	RS	14	

Thickness after Pressing

B00: 2290 µm Tol+: 240 µm Tol-: 240 µm Dmax: 2530 µm Dmin: 2050 µm

Thickness over all

0 µm Tol+: 0 µm Tol-: 0 µm Dmax: 0 µm Dmin: 0 µm

Demand for customer

Thickness (D): 2400 µm Tol+: 240 µm Tol-: 240 µm Dmax: 2640 µm Dmin: 2160 µm

Measuring point: (05) over SM and galv. Cu; both sides

nominal: 2365 µm

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